

Hyper SuperServer SYS-122HA-TN-LCC

1U Hyper with 12 hot-swap 2.5" NVMe bays and 2 PCIe 5.0 x16 + 1 PCIe 5.0 x16 AIOM slot



Key Applications

Artificial Intelligence (AI), Virtualization, High Performance Computing, Data Analytics,

Key Features

- Dual Intel® Xeon® 6900-Series Processors with P-cores up to 500W with D2C liquid cooling;
- Up to 24 DIMMs supporting up to 6TB 6400MT/s DDR5 RDIMM or 3TB 8800MT/s DDR5 MRDIMM;
- 12 2.5" hot-swap NVMe drive bays;
- 2 PCIe 5.0 x16 slots (full-height, 10.5" length);
- 1 AIOM/OCP 3.0 NIC slot for flexible networking options;
- Redundant titanium level power supplies with options from 1600W to 2600W;
- 1U Rackmount chassis with 30.66" (778.7mm) depth;



Form Factor	1U Rackmount Enclosure: 437 x 43 x 778.7mm (17.2" x 1.7" x 30.66") Package: 672 x 224 x 1100mm (26.46" x 8.82" x 43.31")
Processor	Dual Socket BR (LGA-7529) Intel® Xeon® 6900 series processors with P-cores Up to 128C/256T; Up to 504MB Cache per CPU
System Memory	Slot Count: 24 DIMM slots Max Memory (1DPC): Up to 6TB 6400MT/s ECC DDR5 RDIMM Max Memory (1DPC): Up to 3TB 8800MT/s ECC DDR5 MRDIMM
Drive Bays Configuration	Default: Total 12 bays <ul style="list-style-type: none"> • 12 front hot-swap 2.5" NVMe drive bays M.2: 2 M.2 PCIe 5.0 x2 NVMe slots (M-key 2280/22110)
Expansion Slots	Default <ul style="list-style-type: none"> • 2 PCIe 5.0 x16 FH/10.5"L slots • 1 PCIe 5.0 x16 AIOM slot (OCP 3.0 compatible)
On-Board Devices	NVMe: NVMe; RAID 0/1/5/10 support(Intel® VROC RAID key required) Chipset: System on Chip Network Connectivity: Via AIOM
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port USB: 2 USB 3.0 ports(rear) 1 USB 3.0 port(front) Video: 1 VGA port

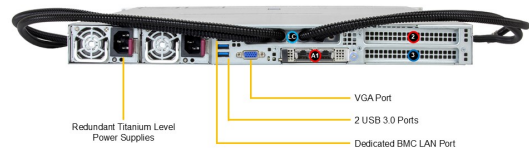
(Front View – System)



Drive Bay	Description
1 – 4	6 Hot-swap 2.5" NVMe/SAS/SATA3 Drive Bays (NVMe from CPU1)
5 – 8	6 Hot-swap 2.5" NVMe/SAS/SATA3 Drive Bays (NVMe from CPU2)

*NVMe, SAS3, or SATA3 support requires additional parts from the optional parts kit

(Rear View – System)



Slot	Slot Description
1	PCIe 5.0 x16 FH/10.5" L
2	PCIe 5.0 x16 FH/10.5" L
3	PCIe 5.0 x16 AIOM (OCP 3.0)
4	Liquid Cooling Tubes

CPU1 CPU2 Liquid Cooling

System Cooling	Fans: 8 counter-rotating 40x40x56mm Fan(s) Liquid Cooling: Direct to Chip (D2C) Cold Plate
Power Supply	2x 1600W Redundant (1 + 1) Titanium Level (96%) Hot-plug power supplies
System BIOS	BIOS Type: AMI 64MB SPI Flash
Management	SuperCloud Composer®; Supermicro Server Manager (SSM); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment Thermal Control for fan connectors
Dimensions and Weight	Weight: Gross Weight: 41.4 lbs (18.8 kg) Net Weight: 19.2 lbs (8.7 kg) Available Color: Silver
Operating Environment	Operating Temperature: 10°C to 35°C (50°F to 95°F) Non-operating Temperature: -40°C to 70°C (-40°F to 158°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)
Motherboard	Super X14DBM-APL
Chassis	CSE-HS101-R000NFP